

1 8. The accelerometer of claim 7, wherein the re-entrant holes are connected
2 beneath the surfaces of the electrodes.

1 9. The accelerometer of claim 7, wherein the size of the re-entrant holes
2 increase in the direction of the periphery of the electrodes.

1 10. A method of operating an accelerometer including a measurement mass
2 for detecting acceleration, including a housing having a cavity, a spring mass
3 assembly positioned within the cavity, and one or more mass electrodes coupled
4 to the spring mass assembly, a top cap wafer coupled to the measurement
5 mass, including a top capacitor electrode, and a bottom cap wafer coupled to the
6 measurement mass, including a bottom capacitor electrode, comprising:

7 reducing fluid damping between the electrodes by providing one
8 or more re-entrant openings in the surfaces of one or more of the electrodes.

1 11. The method of claim 10, wherein the re-entrant openings include one or
2 more re-entrant grooves.

1 12. The method of claim 11, wherein the re-entrant grooves are herringbone
2 shaped.

1 13. The method of claim 11, wherein the re-entrant grooves are criss-crossed.

1 14. The method of claim 11, wherein the re-entrant grooves extend from a
2 central location in a radial direction.

1 15. The method of claim 11, wherein the width of the re-entrant grooves
2 increases in the direction of the periphery of the electrodes.

9 removing the layer of silicon dioxide.

1 22. The method of claim 21, wherein patterning the layer of silicon includes:
 2 patterning the layer of silicon to form a plurality of openings that expose
 3 the layer of silicon dioxide.

1 23. A method of forming a re-entrant opening, comprising:
 2 providing a substrate;
 3 depositing a layer of a masking material onto the substrate;
 4 patterning the masking material to form an opening;
 5 etching the exposed portions of the substrate to form a re-entrant
 6 opening.

1 24. The method of claim 23, wherein the re-entrant opening comprises a
 2 re-entrant groove.

1 25. A method of forming a re-entrant opening, comprising:
 2 providing a substrate;
 3 depositing a first layer of a masking material onto the substrate;
 4 patterning the layer of masking material to form an opening;
 5 etching the exposed portions of the silicon substrate to form a channel;
 6 depositing a second layer of a masking material onto the exposed
 7 portions of the substrate;
 8 patterning the second layer of masking material to form an opening; and
 9 etching the exposed portions of the silicon substrate to form a re-entrant
 10 opening.

1 26. The method of claim 25, wherein the re-entrant opening comprises a
 2 re-entrant groove.

1 27. An accelerometer, comprising:
 2 a measurement mass for detecting acceleration, including a housing
 3 having a cavity, a spring mass assembly positioned within the cavity, and one
 4 or more mass electrodes coupled to the spring mass assembly;
 5 a top cap wafer coupled to the measurement mass, including a top
 6 capacitor electrode; and
 7 a bottom cap wafer coupled to the measurement mass, including a
 8 bottom capacitor electrode;
 9 wherein the surfaces of one or more of the mass electrodes, the top
 10 capacitor electrode, or the bottom capacitor electrode include one or more
 11 grooves.

1 28. The accelerometer of claim 27, wherein the grooves are herringbone
 2 shaped.

1 29. The accelerometer of claim 27, wherein the grooves are criss-crossed.

1 30. The accelerometer of claim 27, wherein the grooves extend from a central
 2 location in a radial direction.

1 31. The accelerometer of claim 27, wherein the width of the grooves
 2 increases in the direction of the periphery of the electrodes.

1 32. A method of operating an accelerometer including a measurement mass
 2 for detecting acceleration, including a housing having a cavity, a spring mass
 3 assembly positioned within the cavity, and one or more mass electrodes coupled
 4 to the spring mass assembly, a top cap wafer coupled to the measurement
 5 mass, including a top capacitor electrode, and a bottom cap wafer coupled to the
 6 measurement mass, including a bottom capacitor electrode, comprising:
 7 reducing fluid damping between the electrodes by providing one or more
 8 grooves in the surfaces of one or more of the electrodes.

- 1 33. The method of claim 32, wherein the grooves are herringbone shaped.
- 1 34. The method of claim 32, wherein the grooves are criss-crossed.
- 1 35. The method of claim 32, wherein the re-entrant grooves extend from a
2 central location in a radial direction.
- 1 36. The method of claim 32, wherein the width of the grooves increases in the
2 direction of the periphery of the electrodes.